

December 2014

FCP380N60E / FCPF380N60E N-Channel SuperFET[®] II Easy-Drive MOSFET **600 V, 10.2 A, 380 m**Ω



Features

- 650 V @ T₁ = 150°C
- Typ. R_{DS(on)} = 320 mΩ
- Ultra Low Gate Charge (Typ. Q_a = 34 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 97 pF)
- 100% Avalanche Tested
- · An Integrated Gate Resistor
- · RoHS Compliant

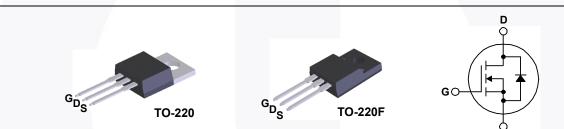
Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the Super-FET II MOSFET series.

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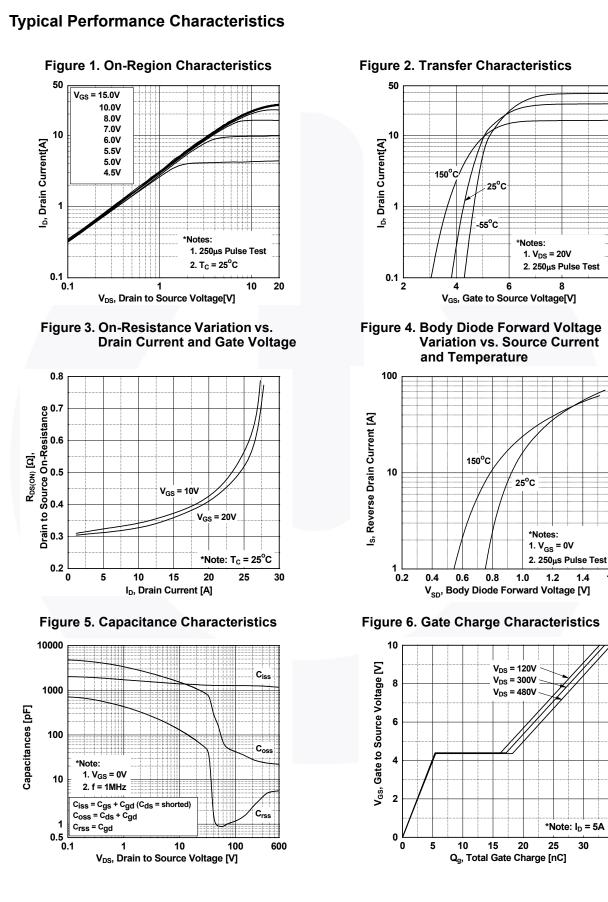
Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter FCP380N60E FCPF380N60E					
V _{DSS}	Drain to Source Voltage	• Voltage			600		
V _{GSS}	Cata ta Sauraa Valtaga	- DC		±20		V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±	30	v	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		10.2	10.2*	А	
		- Continuous (T _C = 100 ^o C)		6.4	6.4*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	30.6	30.6*	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			211.6		mJ	
I _{AR}	Avalanche Current		(Note 1)	2.3		А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	1.06		mJ	
dv/dt	MOSFET dv/dt		1	V/ns			
	Peak Diode Recovery dv/dt		(Note 3)	20		v/115	
P _D	Power Dissipation	(T _C = 25 ^o C)		106	31	W	
		- Derate Above 25°C		0.85	0.25	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to	°C		
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C		
Drain current	limited by maximum junction tem	perature.					

Thermal Characteristics

Symbol	Parameter	FCP380N60E	FCPF380N60E	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.18	4	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	0.00

DE FCP380N60E 0E FCPF380N60E Characteristics T _C = 25 Parameter Pristics Drain to Source Breakdown Volta	TO-220 TO-220F 5ºC unless c	F Tube	N/A N/A		N/A N/A Typ.	50 u	units units
Characteristics T _C = 25 Parameter pristics		otherwise noted.					inits
Parameter	5ºC unless c		ns	Min.	Typ.		I
Parameter			ns	Min.	Tvp.	Max	
					7 1	Max.	Unit
Drain to Source Breakdown Volta							
Jrain to Source Breakdown Volta		V _{GS} = 0 V, I _D = 10 mA, T	_ = 25°C	600	-	-	
an to Source Breakdown Voltage		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$		650	-	-	V
Breakdown Voltage Temperature Coefficient		$I_D = 10$ mA, Referenced to $25^{\circ}C$		-	0.67	-	V/°C
Drain to Source Avalanche Breakdown Voltage		V _{GS} = 0 V, I _D = 10 A		-	700	-	V
Zero Gate Voltage Drain Current		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
		$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	- 0.84	-	μA
Gate to Body Leakage Current		$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			-	±100	nA
ristics							
Gate Threshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$		2.5	-	3.5	V
0				-	0.32	0.38	Ω
Forward Transconductance		00 2			10	-	S
aracteristics			I		1	I	
		$V_{\rm DS} = 25 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$			1330	1770	pF
Output Capacitance				-	945	1260	pF
Reverse Transfer Capacitance		t = 1 MHz		-	60	90	pF
Output Capacitance		V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	25	-	pF
				-	97	-	pF
				-	34	45	nC
Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance		$V_{GS} = 10 V$ (Note 4)		-	5.3	-	nC
				-		_	nC
				-	6	-	Ω
				<u> </u>	17	44	ns
		$V_{DD} = 380 \text{ V}$ ID = 5 A					ns
		$V_{GS} = 10 \text{ V}, \text{R} = 4.7 \Omega$		-			ns
,		(Note 4)		-	-		ns
			(1010 4)		10	00	110
	ource Diode	e Forward Current		-	-	10.2	A
Aaximum Pulsed Drain to Source				-		30.6	A
naximum ruised diam to source		$V_{GS} = 0 V$, $I_{SD} = 5 A$		-	-	1.2	V
	'oltage	$V_{GS} = 0 V$, $I_{SD} = 3 A$					
Drain to Source Diode Forward V Reverse Recovery Time	/oltage	$V_{GS} = 0 V, I_{SD} = 5 A$ $V_{GS} = 0 V, I_{SD} = 5 A,$		-	240	-	ns
	Drain to Source Avalanche Break Voltage Zero Gate Voltage Drain Current Gate to Body Leakage Current ristics Gate Threshold Voltage Static Drain to Source On Resist Forward Transconductance aracteristics nput Capacitance Dutput Capacitance Reverse Transfer Capacitance Dutput Capacitance Effective Output Capacitance Fotal Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance haracteristics Furn-On Delay Time Furn-On Rise Time Furn-Off Delay Time Furn-Off Fall Time e Diode Characteristics	Drain to Source Avalanche Breakdown Voltage Zero Gate Voltage Drain Current Gate to Body Leakage Current ristics Gate Threshold Voltage Static Drain to Source On Resistance Forward Transconductance aracteristics nput Capacitance Dutput Capacitance Dutput Capacitance Effective Output Capacitance Effective Output Capacitance Effective Output Capacitance Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge Equivalent Series Resistance haracteristics Furn-On Delay Time Furn-On Rise Time Furn-Off Delay Time Furn-Off Fall Time e Diode Characteristics	DefinitionProvide the second sec	DefinitionPDrain to Source Avalanche Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 10 \text{ A}$ Zero Gate Voltage Drain Current $\frac{V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}}{V_{DS} = 480 \text{ V}, T_C = 125^{\circ}\text{C}}$ Gate to Body Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ risticsStatic Drain to Source On Resistance $V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$ Gate Threshold Voltage $V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$ Forward Transconductance $V_{DS} = 20 \text{ V}, I_D = 5 \text{ A}$ aracteristicsmput Capacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ Reverse Transfer Capacitance $V_{DS} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 0 \text{ V}$ Output Capacitance $V_{DS} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}$ Dutput Capacitance $V_{DS} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}$ Dutput Capacitance $V_{DS} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}$ Date to Darin "Miller" Charge $V_{CS} = 10 \text{ V}$ Equivalent Series Resistance $f = 1 \text{ MHz}$ haracteristics $V_{DD} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}, R = 4.7 \Omega$ furn-On Delay Time $V_{DD} = 380 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}, R = 4.7 \Omega$ furn-Off Fall Time(Note 4)	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $



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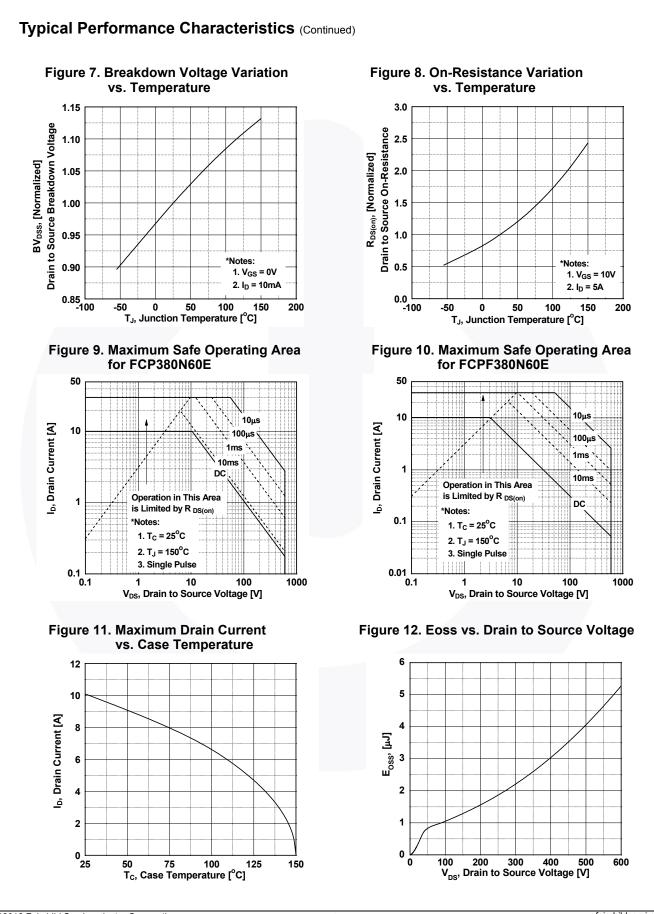
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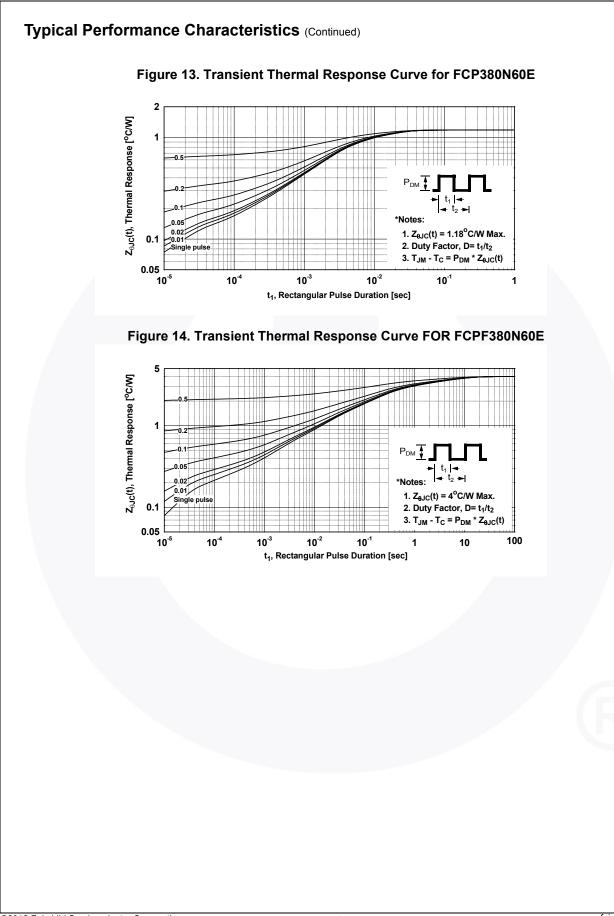
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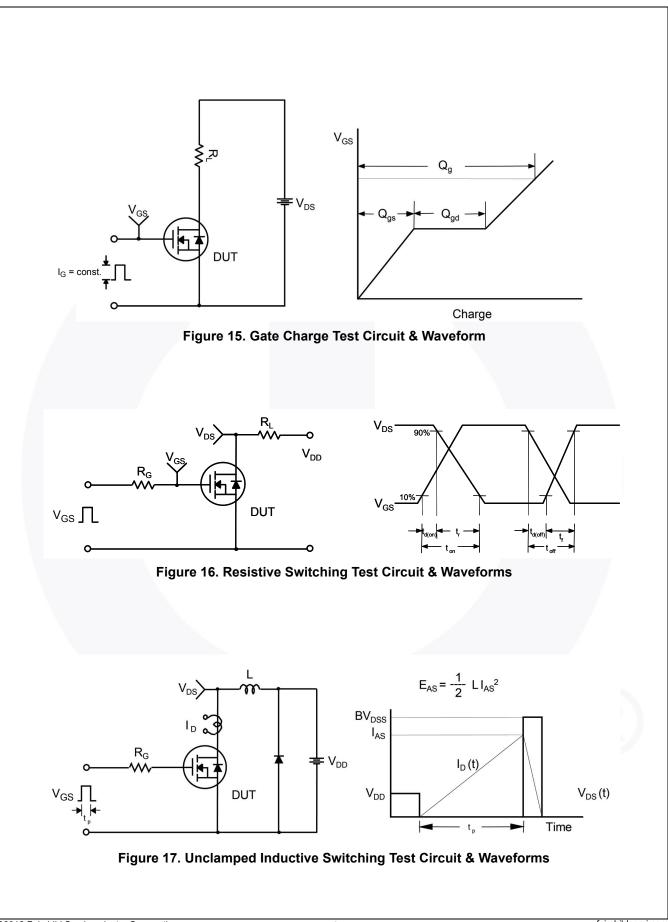


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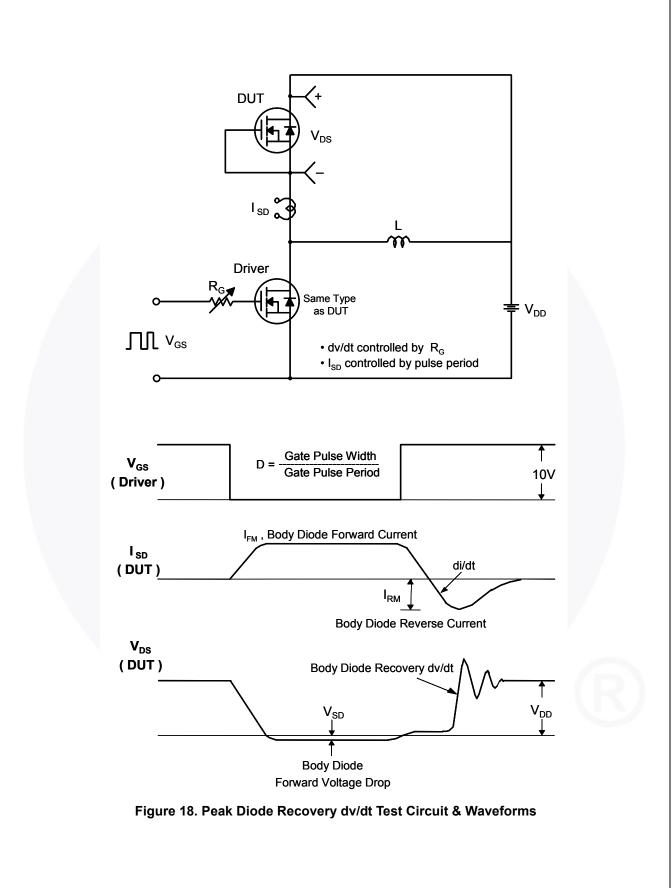
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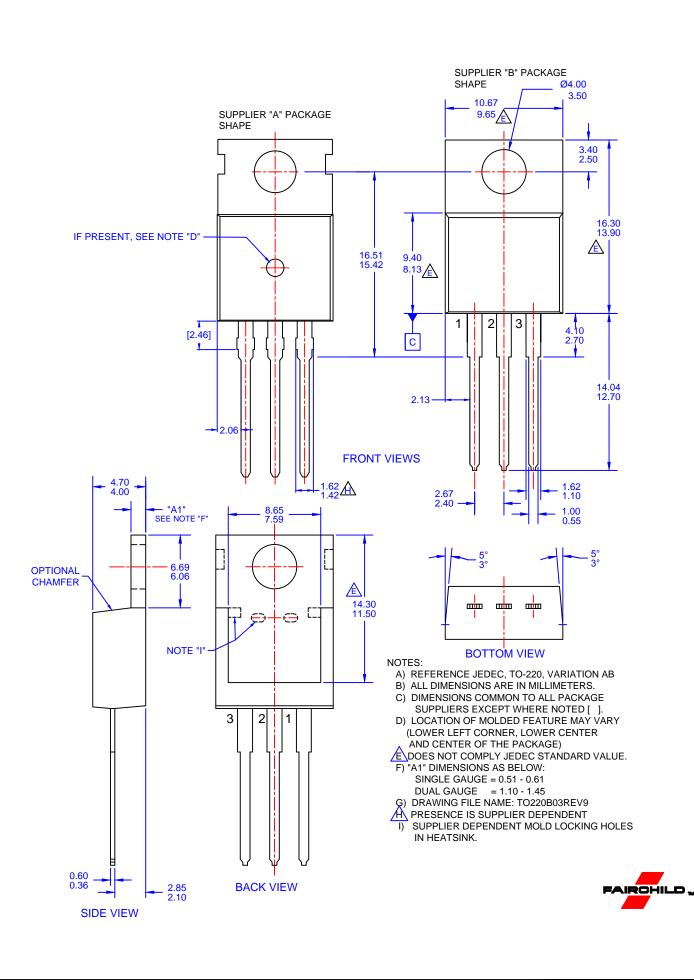
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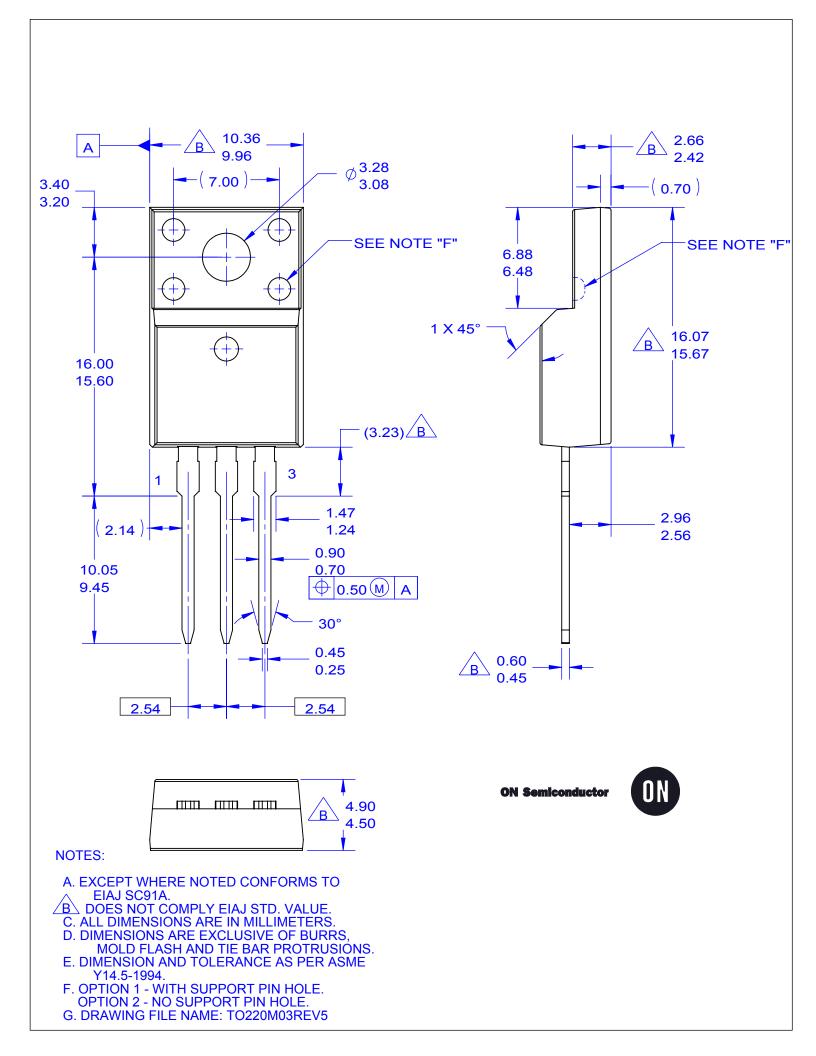


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